

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

|                                 |   |                        |
|---------------------------------|---|------------------------|
| In re Patent Application of:    | ) |                        |
|                                 | ) |                        |
| Ashay A. Dani, et al.           | ) |                        |
|                                 | ) | Examiner: Sheeba Ahmed |
| Application No.: 10/038,334     | ) |                        |
|                                 | ) | Art Unit: 1773         |
| Filed: October 18, 2001         | ) |                        |
|                                 | ) |                        |
| For: THERMAL INTERFACE MATERIAL | ) |                        |
| AND ELECTRONIC ASSEMBLY         | ) |                        |
| HAVING SUCH A THERMAL           | ) |                        |
| INTERFACE MATERIAL              | ) |                        |
| <hr/>                           |   |                        |

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated February 1, 2006, Applicant respectfully requests that the above-identified application be amended as follows and that the following remarks be considered: